

# PMEG3020EPAS

30 V, 2 A low VF MEGA Schottky barrier rectifier

19 January 2015

**Product data sheet** 

## 1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in an ultra thin DFN2020D-3 (SOT1061D) leadless small Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

#### 2. Features and benefits

- Average forward current I<sub>F(AV)</sub> ≤ 2 A
- Reverse voltage V<sub>R</sub> ≤ 30 V
- Low forward voltage V<sub>F</sub> ≤ 470 mV
- Low reverse current
- Reduced Printed-Circuit-Board (PCB) area requirements
- Exposed heat sink (cathode pad) for excellent thermal and electrical conductivity
- Leadless small SMD plastic package with visible and solderable side pads
- Suitable for Automatic Optical Inspection (AOI) of solder joints
- AEC-Q101 qualified

# 3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch Mode Power Supply (SMPS)
- Free-wheeling application
- · Reverse polarity protection
- Low power consumption application
- Battery chargers for mobile equipment
- LED backlight for mobile application

### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; $T_{amb} \le 65$ °C; square wave	[1]	-	-	2	Α
		$\delta$ = 0.5; f = 20 kHz; $T_{sp} \le$ 140 °C; square wave		-	-	2	Α
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C		-	-	30	V



Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>F</sub>	forward voltage	$I_F$ = 2 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C; pulsed	-	410	470	mV
I <sub>R</sub>	reverse current	$V_R$ = 30 V; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C; pulsed	-	435	2500	μΑ

<sup>[1]</sup> Device mounted on a ceramic Printed-Circuit Board (PCB),  $Al_2O_3$ , standard footprint.

# **Pinning information**

Table 2. **Pinning information** 

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	Α	anode	3	3 - 1, 2
2	Α	anode		006aab624
3	К	cathode	Transparent top view	
			DFN2020D-3 (SOT1061D)	

# **Ordering information**

Table 3. **Ordering information** 

Type number	Package				
	Name	Description	Version		
PMEG3020EPAS	DFN2020D-3	DFN2020D-3: plastic thermal enhanced ultra thin small outline package; no leads; 3 terminals; body 2 x 2 x 0.65 mm	SOT1061D		

# **Marking**

Table 4. **Marking codes** 

Type number	Marking code
PMEG3020EPAS	CP

## 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C		-	30	V
I <sub>F</sub>	forward current	T <sub>sp</sub> ≤ 135 °C; δ = 1		-	2.8	Α
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; $T_{amb} \le 65$ °C; square wave	[1]	-	2	A
		$\delta$ = 0.5; f = 20 kHz; T <sub>sp</sub> ≤ 140 °C; square wave		-	2	A
I <sub>FRM</sub>	repetitive peak forward current	$t_p \le 1 \text{ ms}; \ \delta \le 0.25$	[2]	-	7	Α
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8 ms; $T_{j(init)}$ = 25 °C; square wave	[2]	-	17	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[3]	-	500	mW
			[4]	-	960	mW
			[1]	-	1800	mW
Tj	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

- [1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [2] Both anode pins connected.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

#### 9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub> thermal resistance from junction to ambient		in free air	[1][2]	-	-	250	K/W
			[1][3]	-	-	130	K/W
	ambient		[1][4]	-	-	70	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[5]	-	-	12	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.
- 2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [5] Soldering point of cathode tab.

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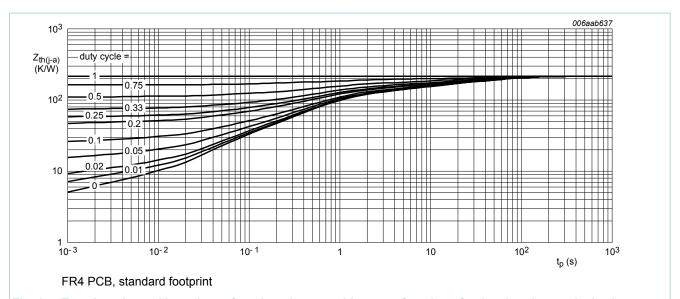


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

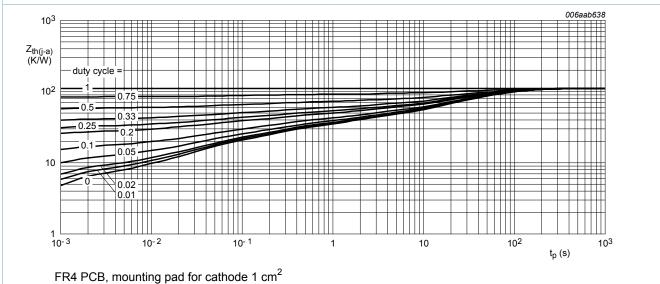
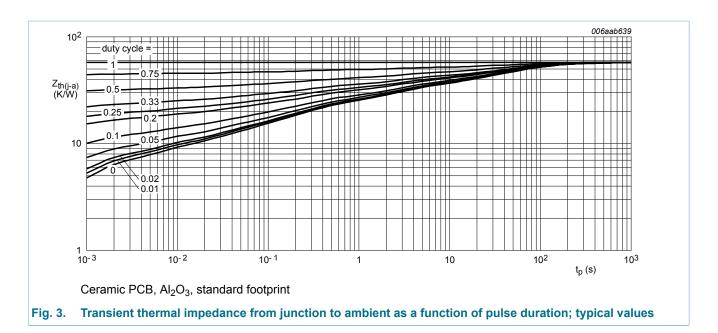


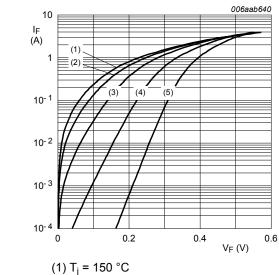
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



## 10. Characteristics

Table 7. **Characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	$I_R$ = 15 mA; $t_p$ = 300 μs; $δ$ = 0.02; $T_j$ = 25 °C; pulsed	30	-	-	V
V <sub>F</sub>	forward voltage	$I_F$ = 0.5 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C; pulsed	-	290	-	mV
		$I_F$ = 1 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C; pulsed	-	335	-	mV
		$I_F$ = 2 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C; pulsed	-	410	470	mV
I <sub>R</sub> reverse	reverse current	$V_R$ = 10 V; $t_p \le 300 \ \mu s$ ; δ ≤ 0.02; $T_j$ = 25 °C; pulsed	-	100	-	μA
		$V_R$ = 30 V; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C; pulsed	-	435	2500	μA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	150	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	55	-	pF
t <sub>rr</sub>	reverse recovery time	$I_F = 0.5 \text{ A}; I_R = 1 \text{ A}; I_{R(meas)} = 0.25 \text{ A};$ $T_j = 25 ^{\circ}\text{C}$	-	4	-	ns



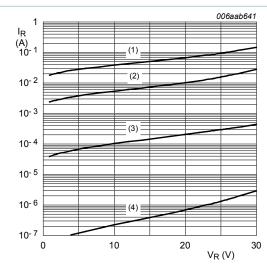


(2) 
$$T_j = 125 \,^{\circ}\text{C}$$

(4) 
$$T_i = 25$$
 °C

(5) 
$$T_j = -40 \,^{\circ}\text{C}$$

Fig. 4. Forward current as a function of forward voltage; typical values



(1)  $T_i = 125 \, ^{\circ}C$ 

(2) 
$$T_j = 85 \, ^{\circ}C$$

(3) 
$$T_j = 25$$
 °C

(4) 
$$T_i = -40 \, ^{\circ}C$$

Fig. 5. Reverse current as a function of reverse voltage; typical values

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<sup>(3)</sup>  $T_i = 85 \, ^{\circ}C$ 

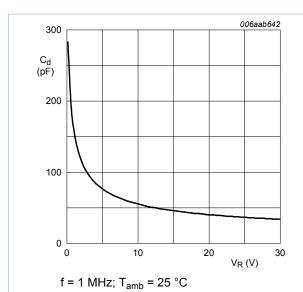
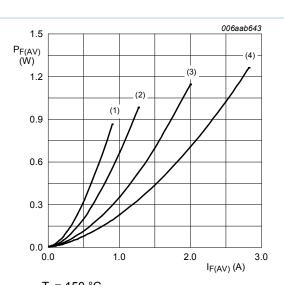
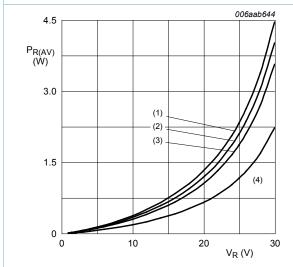


Fig. 6. Diode capacitance as a function of reverse voltage; typical values



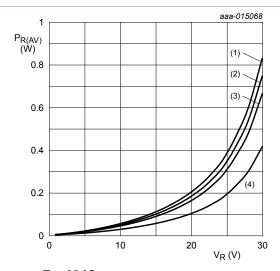
 $T_j = 150 \text{ °C}$ (1)  $\delta = 0.1$ (2)  $\delta = 0.2$ (3)  $\delta = 0.5$ (4)  $\delta = 1$ 

Fig. 7. Average forward power dissipation as a function of average forward current; typical values



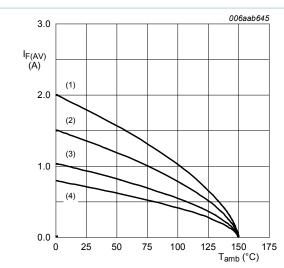
 $T_j = 125 \,^{\circ}\text{C}$ (1)  $\delta = 1$ (2)  $\delta = 0.9$ (3)  $\delta = 0.8$ (4)  $\delta = 0.5$ 

Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



 $T_j = 85 \,^{\circ}\text{C}$ (1)  $\delta = 1$ (2)  $\delta = 0.9$ (3)  $\delta = 0.8$ (4)  $\delta = 0.5$ 

Fig. 9. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T<sub>i</sub> = 150 °C

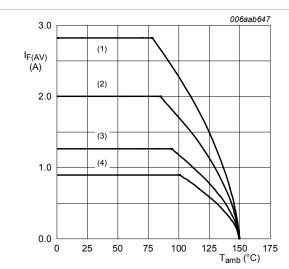
(1)  $\delta$  = 1; DC

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint

T<sub>i</sub> = 150 °C

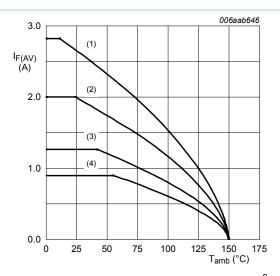
(1)  $\delta$  = 1; DC

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta$  = 0.1; f = 20 kHz

Fig. 12. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

T<sub>i</sub> = 150 °C

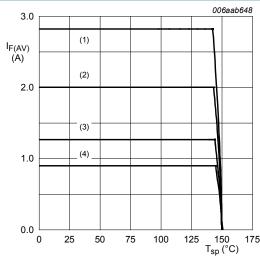
(1)  $\delta$  = 1; DC

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



T<sub>i</sub> = 150 °C

(1)  $\delta$  = 1; DC

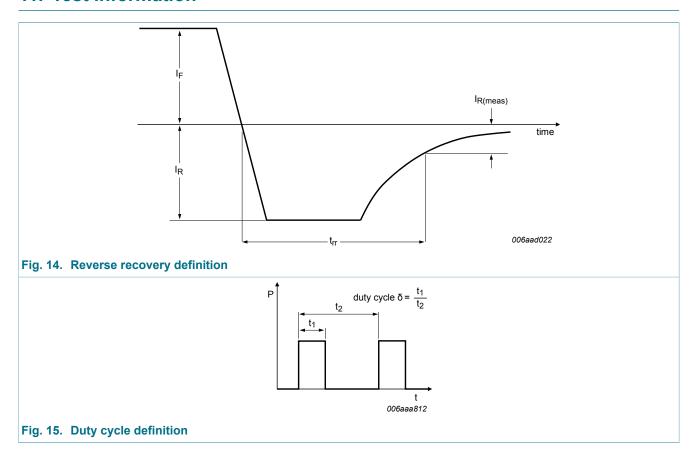
(2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta$  = 0.1; f = 20 kHz

Fig. 13. Average forward current as a function of solder point temperature; typical values

### 11. Test information

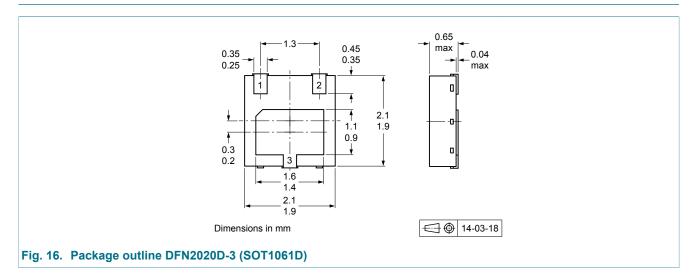


The current ratings for the typical waveforms are calculated according to the equations:  $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

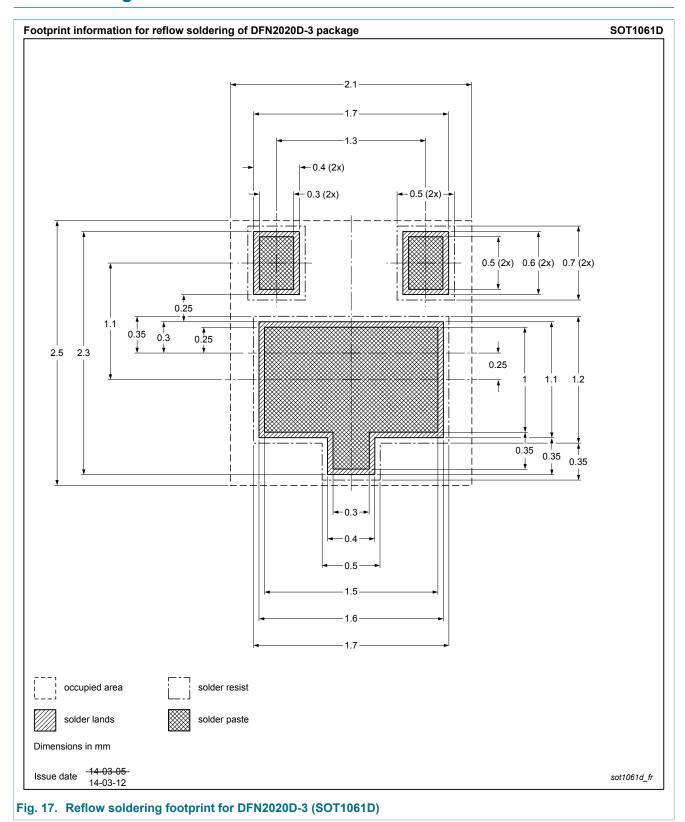
### 11.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

# 12. Package outline



# 13. Soldering



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# 14. Revision history

#### Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PMEG3020EPAS v.2	20150119	Product data sheet	-	PMEG3020EPAS v.1			
Modification:	Product status changed						
PMEG3020EPAS v.1	20141208	Preliminary data sheet	-	-			

## 15. Legal information

#### 15.1 Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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